

ISCAS 2026

2026 IEEE International Symposium on Circuits and Systems



IEEE

MAY 24-27, 2026

**International Convention Center
Shanghai, China**



CALL FOR PAPERS

The IEEE International Symposium on Circuits and Systems (ISCAS) is the flagship conference of the IEEE Circuits and Systems Society and the world's premier forum for researchers in the active fields of theory, design and implementation of circuits and systems. ISCAS 2026 will be held in Shanghai, China, from May 24 to 27, 2026. ISCAS 2026 is driven by the theme “Circuits and Systems for Intelligent Society”, catalyzing transformative innovation at the intersection of circuits, systems, and Artificial Intelligence to foster the development of a smart and sustainable society.

This symposium will include technical oral lectures and poster sessions, special sessions, tutorials, live demonstrations and workshops on emerging topics, covering various topics in circuits and systems.

Collecting contributions in areas of Circuits and Systems, including but not limited to:

- » Analog and Mixed Signal Circuits and Systems
- » Digital Integrated Circuits and System
- » Power and Energy Circuits and Systems
- » Sensory Circuits and Systems
- » Nonlinear Systems and Circuit Theory
- » Digital Signal Processing
- » Multimedia Systems and Applications
- » Communications Circuits and Systems
- » Biomedical Circuits and Systems
- » Neural Networks and Neuromorphic Engineering
- » High-performance Computing for AI
- » Circuits and Systems for Quantum Computing
- » Beyond CMOS: Nanoelectronics and Heterogeneous
- » Education in Circuits and Systems

Important Dates

Special session proposal:	Aug. 26	2025
Special session decision:	Sep. 2	2025
Special session paper submission:	Oct. 12	2025
Regular paper submission:	Oct. 12	2025
Tutorials proposal:	Oct. 20	2025
Tutorial proposal decision	Nov 3	2025
Tutorial final slides submission	May 1	2026
Live demo submission:	Oct. 26	2025
Author notification:	Jan. 19	2026
Final paper submission:	Feb. 9	2026

Selected papers will be invited for possible publication in the IEEE Transactions on Circuits and Systems I: Regular Papers, IEEE Transactions on Circuits and Systems II: Express Briefs, IEEE Transactions on Biomedical Circuits and Systems, IEEE Open Journal of Circuits and Systems, IEEE Transactions on Circuits and Systems for Artificial Intelligence, or IEEE Transactions on Very Large Scale Integration Systems.



2026.ieee-iscas.org

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